

## **Preliminary Specifications**

# **GaAs MMIC** Power Amplifier 2 - 6 GHz

## MAAM26100-P1

V1.A

#### **Features**

- +30 dBm Saturated Output Power
- 18 dB Typical Gain
- 30% Power Added Efficiency
- On-Chip Bias Network
- DC Decoupled RF Input and Output
- High Performance Ceramic Bolt Down Package

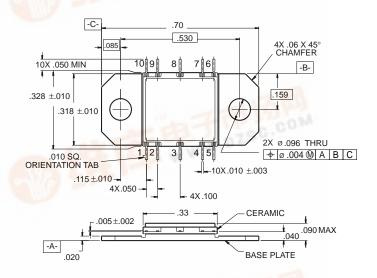
#### Description

M/A-COM's MAAM26100-P1 is a GaAs MMIC two stage high efficiency power amplifier in a high performance bolt down ceramic package. The MAAM26100-P1 is a fully monolithic design for operation in 50-ohm systems, with an on-chip negative bias network which eliminates the need for external bias circuitry.

The MAAM26100-P1 is ideally suited for driver amplifiers and transmitter outputs in Electronic Warfare Jammers, Missile Subsystems and Phased Array Radars.

M/A-COM's MAAM26100-P1 is fabricated using a mature 0.5-micron gate length GaAs process. The process features full passivation for increased performance reliability.

#### **CR-15**



Notes: (unless otherwise specified)

- 1. Dimensions are inches.
- 2. Tolerance: in .xxx =  $\pm$ .010

#### **Ordering Information**

North America:

Part Number	Package		
MAAM26100-P1	Ceramic Bolt Down		

## Typical Electrical Specifications, $T_A = +25$ °C, $V_{DD} = +8$ V, $V_{GG} = -5$ V

Parameter	Test Conditions		Units	Min.	Тур.	Max.
Small Signal Gain	P <sub>IN</sub> ≤ -10 dBm	2 - 6 GHz	dB		18	
Input VSWR	P <sub>IN</sub> ≤ -10 dBm	2 - 6 GHz			2.0:1	
Output VSWR	P <sub>IN</sub> ≤ -10 dBm	2 - 6 GHz			2.2:1	
Output Power	P <sub>IN</sub> = +15 dBm	2 - 6 GHz	dBm		+30	
Power Added Efficiency	P <sub>IN</sub> = +15 dBm	2 - 6 GHz	%		30	
Output IP <sub>3</sub>		2, 5 & 6 GHz	dBm		40	

The Preliminary Specifications Data Sheet Contains Typical Electrical Specifications Which May Change Prior to Final Introduction.

Tel. (800) 366-2266

Asia/Pacific: Tel. +81 (03) 3226-1671

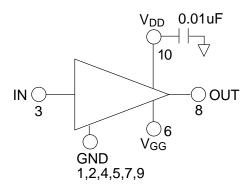
Europe: Tel. +44 (1344) 869 595

#### Absolute Maximum Ratings<sup>1, 2</sup>

Parameter	Absolute Maximum
V <sub>DD</sub>	10 Volts
V <sub>GG</sub>	-10 Volts
Power Dissipation	8.4 W
RF Input Power	+23 dBm
Channel Temperature	150°C
Storage Temperature	-65°C to +150°C
Thermal Resistance (Channel to Case)	15°C/W

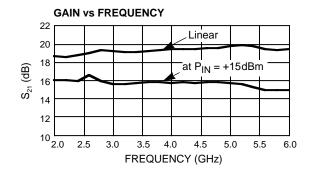
- 1. Exceeding these limits may cause permanent damage.
- 2. Case Temperature (Tc) = +25°C

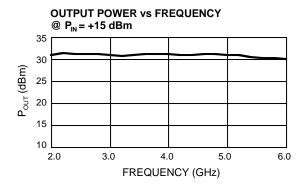
#### Functional Diagram<sup>3,4</sup>

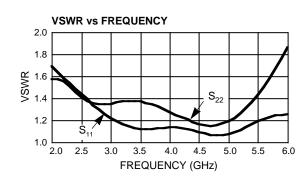


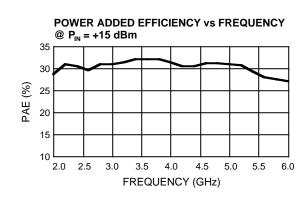
- 3. Nominal bias is obtained by first connecting -5 volts to pin 6 (VGG), followed by connecting +9 volts to pin 10 (VDD).
- 4. RF ground and thermal interface is the flange (case bottom). Adequate heat sinking is required.

### Typical Performance @+25°C









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